TOSHIBA 2SK2698

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE (π -MOS V)

2 S K 2 6 9 8

HIGH SPEED, HIGH VOLTAGE SWITCHING APPLICATIONS DC-DC CONVERTER, RELAY DRIVE AND MOTOR DRIVE APPLICATIONS

Low Drain-Source ON Resistance : $R_{DS(ON)} = 0.35\Omega$ (Typ.)

High Forward Transfer Admittance : $|Y_{fs}| = 11S$ (Typ.)

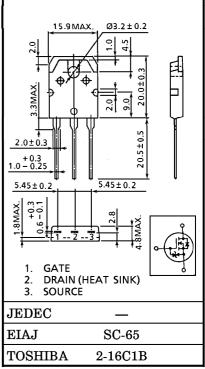
Low Leakage Current : $I_{DSS} = 100 \mu A \text{ (Max.)} \text{ (V}_{DS} = 500 \text{ V)}$

: $V_{th} = 2.0 \sim 4.0 \text{V} (V_{DS} = 10 \text{V}, I_D = 1 \text{mA})$ Enhancement-Mode

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERIST	SYMBOL	RATING	UNIT	
Drain-Source Voltage	$v_{ m DSS}$	500	V	
Drain-Gate Voltage ($R_{GS} = 20 k\Omega$)		$v_{ m DGR}$	500	V
Gate-Source Voltage	V_{GSS}	±30	V	
Drain Current	DC	I_{D}	15	A
	Pulse	I_{DP}	60	A
Drain Power Dissipation	$P_{\mathbf{D}}$	150	W	
Single Pulse Avalanche Energy**		EAS	630	mJ
Avalanche Current	I_{AR}	15	A	
Repetitive Avalanche En	E_{AR}	15	mJ	
Channel Temperature	T_{ch}	150	°C	
Storage Temperature Range		$\mathbf{T_{stg}}$	-55~150	°C

INDUSTRIAL APPLICATIONS Unit in mm



Weight: 4.6g

THERMAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL		
Thermal Resistance, Channel to Case	R _{th (ch-c)}	0.833	°C/W
Thermal Resistance, Channel to Ambient	R _{th (ch-a)}	50	°C/W

Note:

- Repetitive rating; Pulse Width Limited by Max. junction temperature.
- ** V_{DD} =90V, Starting T_{ch} =25°C, L=4.76mH, R_G =25 Ω ,

This transistor is an electrostatic sensitive device. Please handle with caution.

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 TOSHIBA Semiconductor Reliability Handbook.

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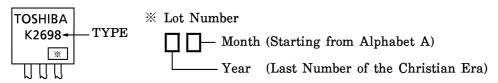
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

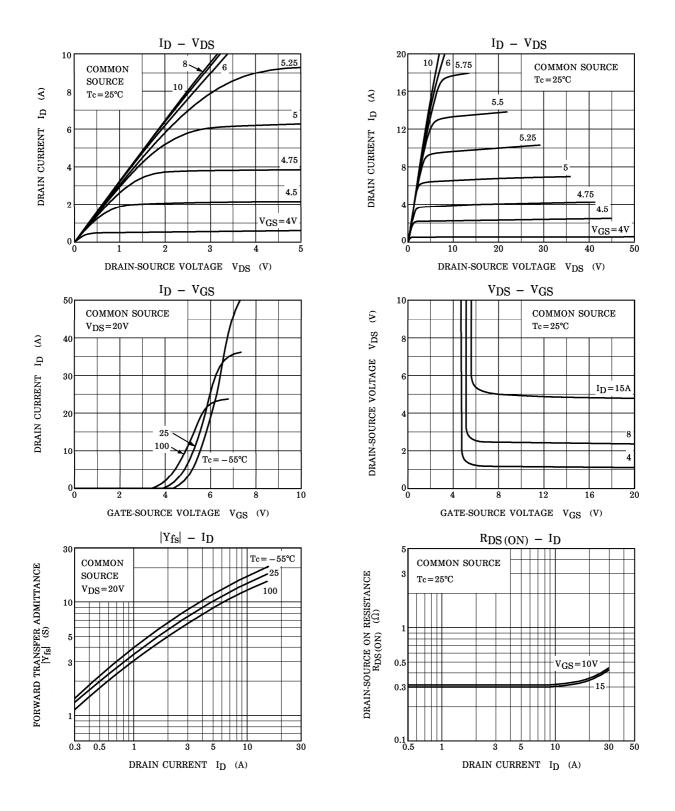
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CHARAC	TERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage	Current	I_{GSS}	$V_{GS} = \pm 25V, V_{DS} = 0V$	_	_	±10	μ A
Gate-Source B Voltage	reakdown	V (BR) GSS	$I_{G} = \pm 10 \mu A, V_{DS} = 0 V$	±30	_	_	v
Drain Cut-off	Current	$I_{ m DSS}$	$V_{DS}=500V, V_{GS}=0V$	_	_	100	μ A
Drain-Source I Voltage	Breakdown	V (BR) DSS	$I_D=10$ mA, $V_{GS}=0$ V	500	_	_	V
Gate Threshol	d Voltage	$V_{ m th}$	$V_{DS}=10V, I_{D}=1mA$	2.0	_	4.0	V
Drain-Source	ON Resistance	R _{DS} (ON)	$V_{GS} = 10V, I_D = 7.0A$	_	0.35	0.4	Ω
Forward Trans Admittance	sfer	Y _{fs}	$V_{DS} = 10V, I_{D} = 7.0A$	6	11	_	S
Input Capacitance Reverse Transfer Capacitance		$\mathrm{c}_{\mathrm{iss}}$	V _{DS} =10V, V _{GS} =0V, f=1MHz	_	2600	_	pF
		C _{rss}		_	280	_	
Output Capacitance		Coss		_	880	_	1
Switching Time Turn-on Fall Tim	Rise Time	t _r	$V_{GS} \stackrel{10V}{_{0V}} \prod \stackrel{I_{D}=7A}{_{VOUT}}$	_	50	_	
	Turn-on Time	t_{on}	V_{DD}	1	85	_	ns
	Fall Time	t_f		1	65	_	
	Turn-off Time	toff	$egin{aligned} & ext{V}_{ ext{IN}}: ext{t}_{ ext{r}}, ext{t}_{ ext{f}}{<}5 ext{ns}, \ & ext{Duty} \leq 1\%, ext{t}_{ ext{W}}{=}10\mu ext{s} \end{aligned}$		260	_	
Total Gate Charge (Gate- Source Plus Gate-Drain)		$\mathbf{Q}_{\mathbf{g}}$	V _{DD} ≒400V, V _{GS} =10V,		58		
Gate-Source Charge		$\mathbf{Q}_{\mathbf{g}\mathbf{s}}$	$I_{D}=15A$	_	36	_	nC
Gate-Drain ("Miller") Charge		$\mathbf{Q}_{\mathbf{gd}}$			22	_	

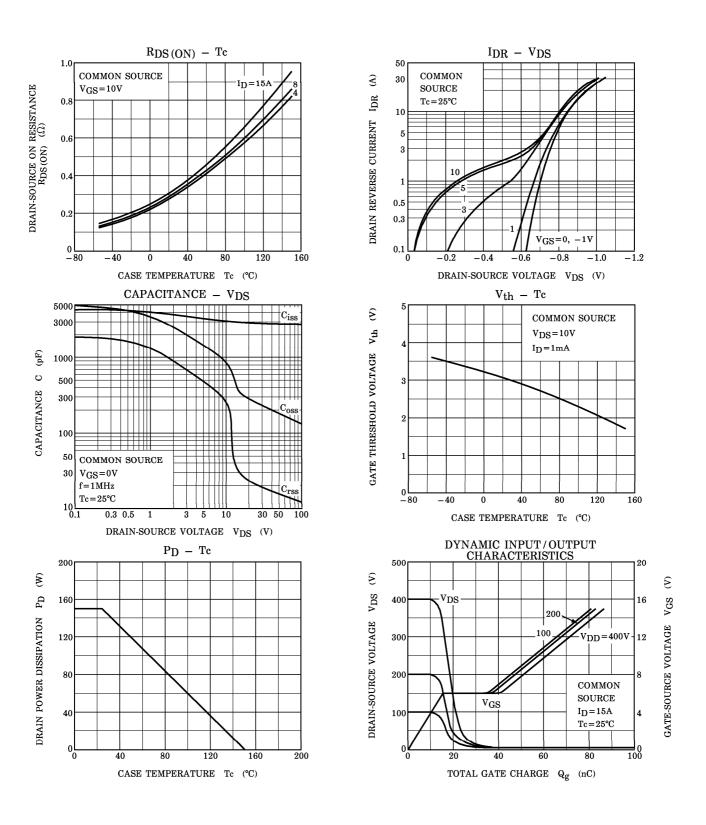
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

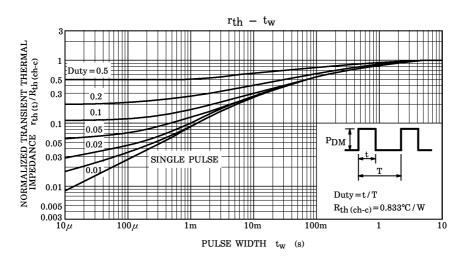
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	$I_{ m DR}$	_	_	_	15	A
Pulse Drain Reverse Current	$I_{ m DRP}$	_	_	_	60	A
Diode Forward Voltage	$V_{ m DSF}$	$I_{DR}=15A, V_{GS}=0V$	_		-1.7	V
Reverse Recovery Time	t_{rr}	$I_{DR}=15A, V_{GS}=0V$		1200	_	ns
Reverse Recovery Charge	$\mathrm{Q_{rr}}$	$ m dI_{DR}/dt\!=\!100A/\mu s$		12	_	μC

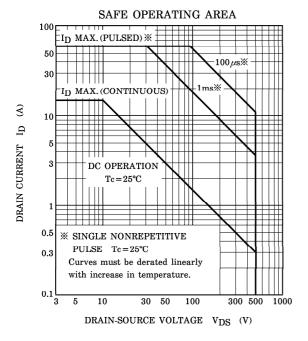
MARKING

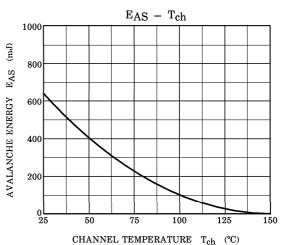


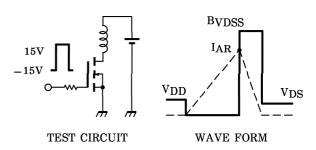












$$\begin{array}{ll} \text{Peak IAR=15A, RG=25}\Omega & \text{EAS=}\frac{1}{2} \cdot \text{L} \cdot \text{I}^2 \cdot (\frac{\text{BVDSS}}{\text{BVDSS-VDD}}) \end{array}$$